

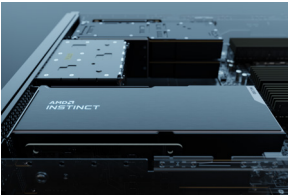
AMD INSTINCT™ GPU FAMILY

GPU ACCELERATORS IN EVERY FORM FACTOR TO PROPEL GENERATIVE AI, TRAINING, INFERENCE, AND HIGH-PERFORMANCE COMPUTING



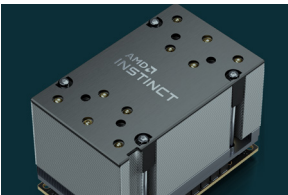
A GPU FAMILY FOR EVERY PURPOSE

Across three generations of AMD CDNA™ architecture, we have delivered amazing performance and energy efficiency for AI training, inference, and high-performance computing, with capabilities and form factors designed to support you wherever you need accelerated computing.



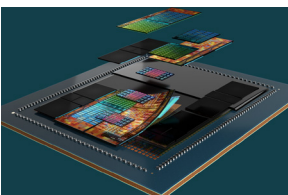
PCIe ACCELERATORS

AMD Instinct™ MI210 and MI250 accelerators are built in a standard full-height, full-length PCIe form factor that can propel workstations that data scientists use in workstations as well as inference servers in the core data center or in edge locations.



OAM ACCELERATORS

The OAM form-factor GPUs are the next step up in performance. Built as standard OAM modules, they are designed with coherent memory across a pod of up to four modules, and up to eight modules when deployed on a universal baseboard.



ACCELERATED PROCESSING UNITS

The Instinct MI300A accelerated processing unit (APU) is built from the ground up to overcome the challenges that discrete

GPUs present: performance bottlenecks from the narrow interfaces between CPU and GPU. Designed to accelerate high-performance computing, the AMD Instinct MI300A integrates 'Zen 4' x86 CPU cores with high-throughput GPU compute units, with a single, shared address space between CPU and GPU. Slated for next-generation supercomputers, this technology is available through platforms offered by our solution partners.



INDUSTRY-STANDARD BASEBOARD FOR PURPOSE-BUILT SERVERS

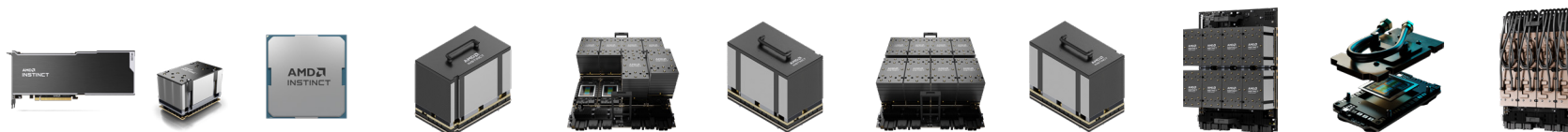
For your most intensive datacenter AI and HPC needs, our OAM-form-factor accelerators are populated eight at a time onto an industry-standard universal baseboard (UBB) to fit into purpose-built servers. Both the MI350 and MI300 Series are enhanced with AI-specific functions including new data-type support, and photo and video decoding.



ROCm

AMD ROCM ECOSYSTEM WITHOUT BORDERS

When you choose a variety of products from the AMD Instinct accelerator family, you need optimized performance from each device. That's not a worry with the AMD ROCm™ platform, which opens doors to new levels of freedom and accessibility. With proven scalability, ROCm software provides support for leading programming languages and frameworks for HPC and AI. With mature drivers, compilers and optimized libraries supporting AMD Instinct accelerators, ROCm provides an open environment that is ready to deploy when you are.

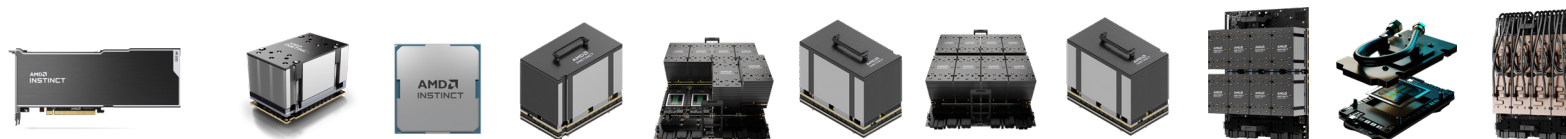


AI PEAK THEORETICAL PERFORMANCE	MI210	MI250	MI250x	MI300A		MI300X		MI300X Platform		MI325X		MI325X Platform		MI350X		MI350X Platform		MI355X		MI 355X Platform	
					sparsity		sparsity				sparsity		sparsity		sparsity		sparsity		sparsity		sparsity
	tera-	tera-	tera-	tera-	peta-	tera-	peta-	tera-	peta-	tera-	tera-	peta-	peta-	tera-	sparsity	peta-	sparsity	tera-	sparsity	peta-	sparsity
FP16 (FLOPS)	181.0	362.1	383.0	980.6	1961.2	1307.4	20.9	10.5	20.9	1307.4	2614.9	10.5	20.9	2306.9	4613.8	18.4	36.8	2516.6	5033.2	20.1	40.3
BFLOAT16 (FLOPS)	181.0	362.1	383.0	980.6	1961.2	1307.4	20.9	10.5	20.9	1307.4	2614.9	10.5	20.9	2309.6	4619.2	18.5	36.9	2516.6	5033.2	20.1	40.3
INT8 (OPS)	181.0	362.1	383.0	1961.2	3922.3	2614.9	41.8	20.9	41.8	2614.9	5229.8	20.9	41.8	4613.7	9227.4	36.9	73.8	5033.2	10,066.4	40.3	80.5
INT4 (POPS)	181.0	362.1	383.0	N/A	N/A	N/A	N/A	N/A	N/A	N/A	N/A	N/A	N/A	4.6137	9.2274	36.9	73.8	5033.2	10,066.4	40.3	80.5
FP8 (FLOPS)	181.0	N/A	NA	1961.2	3922.3	2614.9	41.8	20.9	41.8	2614.9	5229.8	20.9	41.8	4614	9227.4	36.9	73.8	5033.2	10,066.4	40.3	80.5
FP4 (FLOPS)	181.0	362.1	383.0	N/A	N/A	N/A	N/A	N/A	N/A	N/A	N/A	N/A	N/A	9227.5	18455	73.8	147.6	10,066.3	20,132.6	80.5	161.1

HPC PEAK THEORETICAL PERFORMANCE	MI210	MI250	MI250x	MI300A	MI300X	MI300X Platform	MI325X	MI325X Platform	MI350X	MI350X Platform	MI355X	MI 355X Platform
FP64 VECTOR TFLOPS	22.6	45.3	47.9	61.3	81.7	653.7	81.7	653.7	72.1	576.8	78.6	628.8
FP32 VECTOR TFLOPS	22.6	45.3	47.9	122.6	163.4	1307.4	163.4	1307.4	144.2	1.2	157.3	1.3
FP64 MATRIX TFLOPS	45.3	90.5	95.7	122.6	163.4	1307.4	163.4	1307.4	72.1	576.8	78.6	628.8
FP32 MATRIX TFLOPS	45.3	90.5	95.7	122.6	163.4	1307.4	163.4	1307.4	144.2	1.2	157.3	1.3

DECODERS AND VIRTUALIZATION [†]	MI210	MI250	MI250x	MI300A	MI300X	MI300X Platform	MI325X	MI325X Platform	MI350X	MI350X Platform	MI355X	MI 355X Platform
DECODER GROUPS				3	4	32	4	32	4	32	4	32
VIDEO TYPES				HEVC/H.265, AVC/H.264, V1, or AV1			HEVC/H.265, AVC/H.264, V1, or AV1		HEVC/H.265, AVC/H.264, VP9, or AV1	HEVC/H.265, AVC/H.264, V1, or AV1	HEVC/H.265, AVC/H.264, VP9, or AV1	HEVC/H.265, AVC/H.264, V1, or AV1
ZJPEG/MJPEG CODEC				24 cores, 8 cores per group	32 cores, 8 cores per group	256 cores, 8 cores per group	32 cores, 8 cores per group	256 cores, 8 cores per group	40 cores, 10 cores per group	320 cores, 10 cores per group	40 cores, 10 cores per group	320 cores, 10 cores per group
VIRTUALIZATION PARTITION SUPPORT WITH SR-IOV				Up to 3	Up to 8	Up to 64	Up to 8	Up to 64	Up to 8	Up to 8	Up to 8	Up to 64

¹Video codec acceleration (including at least the HEVC (H.265), H.264, VP9, and AV1 codecs) is subject to and not operable without inclusion/installation of compatible media players. GD-176



SPECIFICATIONS	MI210	MI250	MI250x	MI300A	MI300X	MI300X Platform	MI325X	MI325X Platform	MI350X	MI350X Platform	MI355X	MI 355X Platform
FORM FACTOR	PCIe Full-Height, Full-Length (Dual Slot)		OAM module	APU SH5 socket	OAM module	AMD universal baseboard (UBB)	OAM module	AMD universal baseboard (UBB)	OAM module	UBB 2.0 module	OAM module	UBB 2.0 module
FINFET LITHOGRAPHY I/O DIES (IODS)				5nm 6nm	5nm 6nm	5nm 6nm	5nm 6nm	5nm 6nm	TSMC 3nm/6nm FinFET 2 mirrored	TSMC 3nm/6nm FinFET 2 mirrored per module	TSMC 3nm/6nm FinFET 2 mirrored	TSMC 3nm/6nm FinFET 2 mirrored
GPU COMPUTE UNITS	104	208		228	304	2432	304	2432	256	2048	256	2048
MATRIX CORES	416			912	1216	9728	1216	9728	1024	8192	1024	8192
STREAM PROCESSORS	6,656	13,312		14,592	19,456	155,648	19,456	155,648	16,384	131,072	16,384	131,072
PEAK ENGINE CLOCK (MHZ)				2100 MHz	2100 MHz	2100 MHz	2100 MHz	2100 MHz	2200 MHz	2200 MHz	2400 MHz	2400 MHz
X86 CPU CORES	0	0	0	24	0	0	0	0	0	0	0	0
CORE TYPE				'Zen 4								
MEMORY TYPE	HBM2e	HBM2e	HBM2e	HBM3	HBM3	HBM3	HBM3e	HBM3e	HBM3e	HBM3e	HBM3e	HBM3e
MEMORY CAPACITY	64 GB	128 GB	128 GB	128 GB	192 GB	1.5 TB	257 GB	2 TB	288 GB	2.3 TB	288 GB	2.3 TB
MEMORY BANDWIDTH (MAX PEAK THEORETICAL)	Up to 1.6 TB/s	Up to 3.2 TB/s	Up to 3.2 TB/s	5.3 TB/s	5.3 TB/s	5.3 TB/s	5.3 TB/s	6 TB/s	Up to 8 TB/s	8 TB/s	Up to 8 TB/s	8 TB/s per GPU
MEMORY COHERENCY	No	No	Yes	Yes	Yes	Yes	Yes	Yes	Yes (full chip)	Yes	Yes (full chip)	Yes
MEMORY INTERFACE	4096 bits	8192 bits	8192 bits	8192 bits	8192 bits	8192 bits	8192 bits	8192 bits	8192 bits	8192 bits	8192 bits	8192 bits
AMD INFINITY CACHE™ (LAST LEVEL)				256 MB	256 MB	256 MB/GPU	256 MB	256 MB	256 MB	256 MB/GPU	256 MB	256 MB/GPU
MEMORY CLOCK (GT/S)	1.6 GHz	1.6 GHz	1.6 GHz	Up to 5.2	Up to 5.2	Up to 5.2	Up to 5.2	Up to 6	Up to 8	Up to 8	Up to 8	Up to 8
SCALE-UP INFINITY FABRIC™ LINKS	3	6	8	4	7	7	7	7	8	7 (per GPU)	8	7 (per GPU)
LINK BANDWIDTH	100 GB/s	100 GB/s	100 GB/s	128 GB/s	128 GB/s	128 GB/s	128 GB/s	128 GB/s	144 GB/s	144 GB/s	144 GB/s	144 GB/s
AGGREGATE BANDWIDTH PER GPU	300 GB/s	600 GB/s	800 GB/s	256 GB/s	896 GB/s	896 GB/s	896 GB/s	896 GB/s	896 GB/s	1.2 TB/s	896 GB/s	1.2 TB/s
I/O TO HOST CPU	1 x16	1 x16	1 x16	4 x161	1 x16	8 x16	1 x16	8 x16	5 x16	8 x16	5 x16	5 x16
I/O TYPE	PCIe Gen 4	PCIe Gen 4	PCIe Gen 4	PCIe Gen 5	PCIe Gen 5	PCIe Gen 5	PCIe Gen 5	PCIe Gen 5	PCIe Gen 5	PCIe Gen 5	PCIe Gen 5	PCIe Gen 5
I/O BANDWIDTH	Up to 64 GB/s	Up to 64 GB/s	Up to 64 GB/s	128 GB/s	128 GB/s	128 GB/s	128 GB/s	128 GB/s	128 GB/s	128 GB/s	128 GB/s	128 GB/s
RAS FEATURES	ECC memory and RAS support						Full-chip ECC memory, page retirement, page avoidance					
MAXIMUM TBP	300W	500W (air) 560W (DLC)	500W (air) 560W (DLC)	550W (air) 760W (DLC)	750W	750W per GPU	1000W	1000W per GPU	1000W	1000W per module	1400W	1400W per module

1 Assignable to host or GPU-to-GPU connectivity.

1. MI350 Family DS - PID#253461438

Footnote explanations are available at: <https://www.amd.com/en/legal/claims/instinct.html>

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